

Sensors and Materials

Special Issue on Smart Connections and Intelligent Computation in IoT

Call for Papers

Faced with the advent of the era of Internet of Things (IoT), a large number of data applications will enter our lives. Things will be quickly connected to networking via sensors, tags, and data. Thus, the explosive growth of IoT applications creates many scientific and engineering challenges that call for creative research efforts from both academia and industry, especially for the development of efficient and reliable connections and computations. For a meaningful analysis and multi-style fast-moving large amounts of data, providing innovative services to highlight the value of wisdom is actually in needs. This special issue will focus on the innovative results or progress in the development of theoretical, methodological, and practical aspects of IoT, along with innovative or interdisciplinary approaches that will benefit both the academia and industry.

Scope:

- Smart home applications
- Wearable devices and applications
- Innovative sensor deployments and applications
- Artificial intelligence in IoT
- Smart connections and intelligent computations
- Sensor design, integration and combination

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Journal website: <http://myukk.org/>

Guest Editor: Jia-Shing Sheu (National Taipei University of Education)

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(Attention)

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If you have any questions, please feel free to contact the editorial staff at the address below.

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